



# HDSL2 for Total Access 3000

## H2TU-C for Total Access 3000 Form Factor

### Product Features

- Advantageous in areas where unused copper pairs are in short supply
- Will handle the worst case installation scenario - long copper loop afflicted with:
  - Bridged taps
  - Cables running other interfering DSL services
  - 99% degree of electromagnetic coupling between possible "crosstalk" cables and the HDSL2 circuit itself
- Industry-leading, 10-year warranty

**Carriers are deploying a variety of access platforms that deliver multiple services. Many T1 line deployments have been converted to HDSLx technology. In situations where pairs are in short supply, lines have been converted to HDSL2 to save copper pairs. ADTRAN® offers end-to-end HDSL2 card solutions with the Total Access® 3000 Multiservice Platform.**

Total Access 3000 is an intelligent, open-architecture, carrier class multiservice access platform for deploying Hi-Cap and DSL services. Total Access 3000 offers unprecedented flexibility, along with multiple service options and management capabilities. Its real value in a TDM configuration is its ability to deliver T1 lines out to various applications. This compact, modular device is a single platform for delivering manageable, profitable services now and into the future. It supports HDSL, HDSL2, HDSL4, DSX-1, and POTS applications in conjunction with IADs and other network components.

HDSL2 became the next generation of DSL technology for the local loop. Standardization and interoperability were recognized as necessities for any future transmission mode. ADTRAN led the industry development of HDSL2 as a response to carrier needs and the physical demands being placed on copper networks.

The goal of HDSL2 was to transport T1 traffic on a single-pair of copper using CSA design guidelines. By basing deployment on

CSA guidelines, the embedded base of copper facilities and the deployment guidelines used for yesterday's 4-wire HDSL can be used for HDSL2 circuits.

To be a fit for today's copper plant, HDSL2 is compatible with other technologies in the network. Using spectral-shaping techniques, HDSL2 is designed to be compatible with other loop technologies such as ISDN, T1, HDSL and ADSL.

Interoperability between HDSL2 vendors and products accelerated the acceptance of HDSL2 by the service providers. Interoperability also allows for ubiquitous service for T1 transport.

In HDSL2, the entire DS1 payload is carried over a single copper pair. The DS1 payload plus HDSL2 overhead results in 1.552 Mbps transported over the pair.

ADTRAN's HDSL2 central office and remote units are equipped with troubleshooting-at-a-glance LEDs that provide customers with a simple means of identifying the location of certain faults. Several new screens have been added to the craft interface to simplify the trouble isolation process.

These units are equipped to support the ADTRAN TScan™ feature. TScan allows the remote retrieval of circuit diagnostics and performs advanced fault location. For implementation of TScan, please contact your local ADTRAN sales representative.



# HDSL2 for Total Access 3000



## ADTRAN, Inc.

901 Explorer Boulevard  
Huntsville, AL 35806

P.O. Box 140000  
Huntsville, AL 35814-4000

256 963 8000 voice  
256 963 8030 fax  
877 457 5007 fax back

## General Information

800 9ADTRAN  
info@adtran.com  
www.adtran.com

## Pre-Sales

### Technical Support

888 5ADTRAN  
support@adtran.com  
www.adtran.com/support

## Where to Buy

800 827 0807  
www.adtran.com/where2buy

## Post-Sales

### Technical Support

800 726 8663  
support@adtran.com  
www.adtran.com/support

## Regional Offices

Dallas, TX  
972 830 9070  
Denver, CO  
303 471 9150  
Irvine, CA  
949 260 3500  
Kansas City, KS  
800 471 8649  
Newark, NJ  
800 471 8656  
Ontario, Canada  
416 290 0585  
Quebec, Canada  
877 923 8726  
San Antonio, TX  
888 223 7671

## International Inquiries

+1 256 963 8716 voice  
+1 256 963 6300 fax  
international@adtran.com  
www.adtran.com/international



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## H2TU-C for Total Access 3000 Form Factor

# Product Specifications

## Technical Specifications

- **Modulation type:** 16 TC PAM
- **Mode:** Full duplex, partially overlapped echo canceling
- **Number of pairs:** 1
- **Line rate:** 1.552 Mbps
- **Baud rate:** 517.333 kbaud
- **Loop loss:** 35 dB maximum at 196 kHz
- **Bridged taps:** Single taps less than 2000 ft, total taps less than 2500 ft
- **Performance:** Compliant with T1.418-2000 (HDSL2 Standard, Issue 2)
- **H2TU-C transmit power (data) level:** 16.8 ±0.5 dBm (0 to 450 kHz)
- **H2TU-C transmit power (activation) level:** 16.6 ±0.5 dBm (0 to 450 kHz)
- **Input impedance:** 135 ohms
- **Maximum loop resistance:** 900 ohms (nonrepeated circuit)
- **Return loss:** 12 dB (50 kHz to 200 kHz)

## Interfaces

- **Network:** DS3, OC-3
- **Subscriber:** HDSL2

## Electrical

- **H2TU-C total power:** -48 VDC at 160 mA with H2TU-R,
- **Span power:** -190 VDC (internally generated)  
Class A2 compliant, GFI current  
at less than 5 mA, loop current limited at 150 mA
- **Fusing:** 1.00 A (not field replaceable)

## Regulatory Standards

- NEBS Level 3
- GR-1089-CORE, Issue 3
- GR-63-CORE, Issue 2
- NRTL Safety Listed

## Clock

- **Clock sources:** Internal, DSX-1 derived (with HDSL2 frame bit stuffing)
- **Internal clock accuracy:** ±25 ppm (exceeds Stratum 4), meets T1.101 timing requirements

## Environmental

- **Operating temperature:** -40°C to +70°C
- **Storage temperature:** -40°C to +85°C

# Ordering Information

Equipment	Part #
<b>Central Office Form Factors</b>	
Total Access 3000 H2TU-C	1181113L2
<b>Repeaters</b>	
H2R 239	1221045L1
H2R 239 PSD	1221045L2
<b>Remote Units</b>	
T200 Local Power H2TU-R	1223024L2
T200 Span Power H2TU-R	1223026L2

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